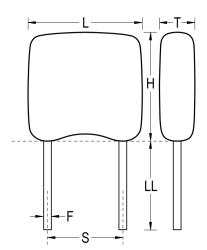


HP08DN104KN

Aliases (HP08DN104K)

HP LDD Indust COG HT200C, Ceramic, 0.1 uF, 10%, 200 VDC, COG, High Temperature, Lead Spacing = 10.16mm



Click here for the 3D model.

Dimensions	
L	12.7mm MAX
Н	12.7mm MAX
Т	6.35mm MAX
S	10.16mm +/-0.762mm
LL	3.175mm MIN
F	0.635mm +0.102/-0.051mm

Packaging Specifications

Packaging	Waffle, Tray
Packaging Quantity	28

General Information		
Series	HP LDD Indust COG HT200C	
Style	Radial	
Description	High Temperature	
Features	LDD High Temperature 200C	
RoHS	No	
Prop 65	A WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.	
SCIP Number	bf6a1307-d7a0-4f9d-aab0-ab892fbcccd4	
Termination	Nickel	
Failure Rate	N/A	
AEC-Q200	No	

Specifications			
Capacitance	0.1 uF		
Measurement Condition	1 kHz 1.0Vrms		
Capacitance Tolerance	10%		
Voltage DC	200 VDC		
Dielectric Withstanding Voltage	500 VDC		
Temperature Range	-55/+200°C		
Temperature Coefficient	COG		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/C, 1kHz 1.0Vrms		
Dissipation Factor	0.15% 1 kHz 1.0Vrms		
Insulation Resistance	10 GOhms		

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